



Aluminum Based Copper Clad Laminate Main Technical Properties

Model Number:1.0W-AL-H-06

Item	Test Condition	Unit	Specification
Dielectric Thickness	/	μm	80-150
Thermal Stress	288°C No delamination, No foaming	s	120s
Pell Strength	C-96/25/65	N/mm	1.6
Break-down Voltage	DC	KV	4-6
Break-down Voltage	AC	KV	1.5-4.5
CTI	IEC60112	V	600
TG	DSC	°C	120
Surface Resistance	C-96/35/90	$M\Omega$	3×10^{13}
Volume Resistivity	C-96/35/90	$M\Omega \cdot \text{cm}$	7×10^{14}
Dielectric Constant 1MHZ	C-96/35/90	/	≤ 4.5
Dissipation Factor 1MHZ	C-96/35/90	/	≤ 0.023
Water Absorption	D-24/23	%	≤ 0.4
Thermal Conductivity	ASTMD5470-12	W/m.k	1.0
Flammability	UL94	/	V-0

Contact us

Clio Tsui

Email: salesxu@greenmark.com.cn

greenmarkclio@gmail.com (MSN)

Skype: clio.tsui Webchat: lihua157314

Mobile: 86-18933590498

Tel: 86-752-5766588

Fax: 86-752-5789053

Website: <http://www.greenmarkccl.com>